Introduction and R2E overview

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https://indico.cern.ch/event/760345/



R2E Annual Meeting

- **Main objective:** to provide a global view of the project to those of you participating in it (i.e. promote internal exchange/collaboration, know whom to ask what, etc.)
- Structure:
 - First day focused on Work Package presentations (mandate, status, outlook...)
 - Second day focused on more specific technical/scientific topics, typically related to student/fellow work
- Feedback welcomed in order to improve for next year's organization



Main R2E building blocks



 $\textit{mitigation} \rightarrow \textit{prevention}$



R2E Work Package structure

A. Operation

A-1: Project Management
[S. Gilardoni/R. Garcia Alia]
A-2: RADWG Support
[S. Danzeca]
A-3: MCWG Support
[Y. Kadi]
A-4: Material Testing and External Facilities
[M. Calviani]
A-5: Injector Chain
[R. Garcia Alia]

B. Infrastructure

B-1: CERN Facilities

[S. Danzeca]
B-2: RadMON
Monitoring
[S. Danzeca]

B-3: Optical Fibre

Dosimetry
[Y. Kadi]
B-4: Shielding & Relocation
[M. Lazzaroni]

C. Radiation Tolerant Developments

C-1: Common Building Blocks [S. Danzeca] C-2: Vacuum [G. Pigny] C-3: Beam Instrumentation [R. Jones/T. Lefevre] C-4: Quench Protection System [R. Denz] C-5: Power Converters [Y. Thurel] C-6: Cryogenics [J. Casas-Cubillo] C-7: Controls [J. Serrano]



RadMON system

- v6 upgrade for LHC (all points except IP4 and IP6)
 - Enhanced radiation lifetime (~250 Gy)
 - Improved TID and HEH fluence sensitivity
 - Direct thermal neutron (R-factor) measurement
- Important not only for LHC, but also for injectors and experimental areas
- Complemented with passive dosimetry (RadFET, nMOS, BatMON); BatMON v7
 - 65nm Cypress memory, floating gate dosimeter
- Continuous operation/maintenance and development activities
- Strong interest from other accelerator/nuclear facilities, as well as for space







Optical fiber dosimetry



- Presently deployed in PSB and PS
- Large dynamic dose range and continuous (~1m resolution) spatial coverage
- LS2 plans: deployment in SPS and LHC dispersion suppressor (IP1, IP5 and IP7)



Radiation level monitoring & reporting

- Monitoring & reporting activity, both upon specific requests, and in terms of general reports
- MCWG radiation level analysis/database: mainly based on processed BLM data (very broad data set), now also including RadMON and extending into injectors
- 2018 LHC radiation level monitoring highlights:
 - Impact of TCL6 collimator settings on RR and DS levels (IP1 and IP5)
 - Increased losses in IP7
 - Evolution of LHC ARC radiation levels
 - Ion BFPP losses





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FLUKA R2E calculations

- Key in determining radiation levels for LIU and HL-LHC configuration and operational conditions
- Efficiently covering large majority of HL-LHC (WP10) areas of concern for equipment groups:
 - Shielded areas (UJ, UL, RR) around IP1, 5 and 7
 - DS in IP1, 5 and 7 (including possible cell 9 location for 11T/TCLD)
- Activity includes also simulations for test facilities (CHARM, CC60) and FCC



HL-LHC dose under cryostat, right of IP5, $\mathcal{L}_{int}^{pp} = 4000 \text{ fb}^{-1}$, $\mathcal{L}_{int}^{ion} = 10 \text{ nb}^{-1}$





2018 impact of R2E on LHC operation

- Main 2018 LHC radiation environment features:
 - Confirmation of very low radiation levels in the LHC arc (<100 mGy/year at equipment location)
 - Increased losses per unit integrated intensity in IP7 due to crossing angle and beta-star settings
 - IP1 & IP5: Tradeoff between RR (lower) and DS (higher) radiation levels
 - BFPP localized ion losses

Operational implications:

- 2018 EPC RR failures in LHC leading to dump (mainly FGC2 controls and 600A power): 11 (factor ~2 reduction of failures per unit integrated luminosity with respect to 2017)
- Significant increase in QPS failures due to (i) increased DS levels in proton operation (cell 8-9),
 (ii) ion operation
 - First signature of radiation lifetime issues (i.e. not SEE related) on LHC equipment → rising edge of bathtub curve
- "Few" SEE-events in commercial systems in shielded areas (e.g. UL PLCs for PIC) → presently in the shadow of operation, but could become more critical with increased radiation levels



R2E test facilities at CERN

• CHARM:

- "Flagship" of CERN radiation facility, tailored for high-energy accelerator environment and system level testing
- Examples of 2018 CHARM accelerator equipment (LS2) tests: 11T uQDS, quench heater power supplies, cold-by pass diode, current lead temperature controller, electronics for pressure sensors...
- Key R2E support for facility operation, interface with users, test preparation & interpretation...
- CC60:
 - In-house solution for TID testing and component and board level
 - Factor ~10 source activity increase for 2019





External facilities for regular R2E qualification

- **PSI** (200 MeV protons):
 - For TID/DD/SEE testing of components for equipment groups (i.e. test service)
 - ~70 references tested in 2018, reports available on <u>radiation test</u> <u>database</u>
- TID tests through **Fraunhofer** (~5 MGy target levels)
 - Relatively new R2E activity; crucial in terms of (i) building and preserving associated know-how, (ii) reducing test campaign cost and person-power
 - Passive tests, typically for materials (i.e. requiring post-irradiation analysis at CERN)



Other test facilities for R2E activities

- Non-conventional irradiation sources & beams at CERN
 - VESPER at CLEAR (high-energy electrons)
 - Am-Be neutron source (e.g. for SEU setup validation)
 - Ultra-high energy heavy ions at CHARM and North Area
- Other external test facilities for recent R2E activities
 - ILL (thermal neutrons) and LPSC (14 MeV neutrons) in Grenoble
 - Low energy protons and ion cocktail at RADEF (Jyvaskyla)
 - Atmospheric-like neutron spectrum for SEE testing at ChipIr (large beam available for board/system level testing)
 - IJS reactor in Ljubljana (mainly displacement damage)
 - Pion testing at PSI (through RADSAGA)
 - GSI high-energy and micro-beam ions







R2E equipment group developments (LS2)

- Power converters:
 - FGClite (already in operation in LHC ARC since EYETS 16-17)
 - 600A & 4-6-8 kA power converters
- GEFE BPM electronics (for SPS)
- QPS:
 - Quench detection system for 11T
 - Upgrade of main quadrupole systems
- Vacuum gauge electronics





Common development examples

- Evaluation of NanoExplore rad-hard FPGA for CERN applications
 - EU effort to build ITAR free rad-hard FPGA based on 65nm ST technology (mainly for space applications, strong ESA support)
 - Very promising radiation test results; lot procurement foreseen for 2019; working on implementing and testing accelerator applications
 - Complementary efforts based on SmartFusion2 (as natural ProAsic3 replacement)
- Support for radiation tolerant elements of **BE/CO DIOT**
 - Ongoing developments (both in-house and through external company collaboration) to provide high-power DCDC converter module (synergies with TE/EPC needs)
 - Initial design and qualification of Powerlink FMC board (baseline solution: soft-core System-on-Chip)







R&D activities related to RHA

- Radiation effects on electronics evolve rapidly, mainly linked to the fast technological evolution
- It is important to keep up-to-date with radiation effects on emerging technologies (e.g. deep sub-micron FPGA, wide-bandgap semiconductors for power and RF electronics) due to (i) obsolescence of older technologies and (ii) enhanced performance
- A lot can be learnt from the well-established radiation effects space community, but "our" environment and needs are unique
- Examples of ongoing R2E R&D activities with direct RHA implications (i.e. how we qualify electronics for the accelerator):
 - **TID and displacement damage synergy effects** on e.g. bipolar components and opto-couplers (how representative is the test environment of the actual operation conditions?)
 - **Impact of intermediate and thermal neutrons** on soft-error rate for LHC shielded areas (what is their relative contribution for state-of-the-art technologies, and how can we qualify in a representative manner?)
 - Radiation effects on wide-bandgap semiconductor technologies (SiC, GaN)



R2E collaboration status

- **Universities** (mainly Montpellier and Jyvaskyla):
 - Collaboration agreements in place (or being implemented); regular student exchange (e.g. trainees, PhDs)
 - Saint Etienne: strong focus on optical fiber dosimetry
- CNES:
 - Very active collaboration, mainly focused on common qualification needs and radiation monitoring
 - CNES-CERN Steering Committee Meeting held in May 2018: <u>https://indico.cern.ch/event/731449/</u>
- ESA
 - Long-standing collaboration focusing on access to CERN and external radiation facilities and respective R&D studies
 - Finalization of protocol on "radiation environments, technologies and facilities", to be signed early 2019
- ITER:
 - Workshop held in May 2018 to provide overview of radiation effects on electronics activities and possible common points of interest: <u>https://indico.cern.ch/event/708324/</u> (possible similar event to be held in 2019 with GSI → 2020: more general workshop on "radiation environments and effects on electronics in high-energy accelerators and nuclear facilities")



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RADSAGA Marie Curie network

- Network of 15 students distributed around different universities, laboratories and companies in Europe; coordinated by CERN
- Working on emerging challenges for radiation effects on electronics in space, avionic, ground-level and accelerator applications
- 4 year project, started March 2017
- Main 2018 achievements relevant to R2E:
 - System-level testing in CHARM (e.g. software defined radio for satellite communication) and implications on RHA guidelines
 - Custom design and calibration of variable voltage supply SRAM radiation monitor
 - On-going rad-hard designs (e.g. CMOS imager)





Many thanks to all!!



(part of the R2E team at RADECS 2018)



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